

ON Semiconductor®

FDMS9408-F085 N-Channel PowerTrench[®] MOSFET

40 V, 80 A, 1.8 m Ω

Features

- Typical $R_{DS(on)}$ = 1.5 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical Q_{g(tot)} = 68 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

Symbol

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems

MOSFET Maximum Ratings

$T_J = 25^{\circ}$ C unless otherwise noted.	D 6 0 7 0 8 1 5
Parameter	Ratings
	40
	±20

Тор

Power 56

V _{DSS}	Drain-to-Source Voltage		40	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 25°C	80	Α
D	Pulsed Drain Current	T _C = 25°C	See Figure 4	A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	143	mJ
р	Power Dissipation		214	W
PD	Derate Above 25°C		1.43	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.7	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W

Notes:

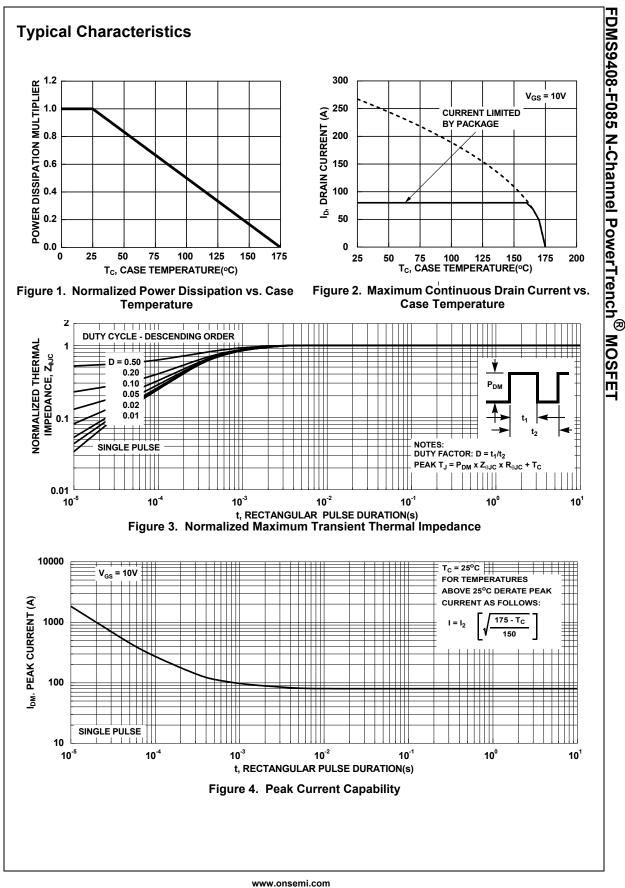
- 1: Current is limited by bondwire configuration.
- 2: Starting $T_J = 25^{\circ}$ C, L = 70uH, $I_{AS} = 64$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder moduling surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

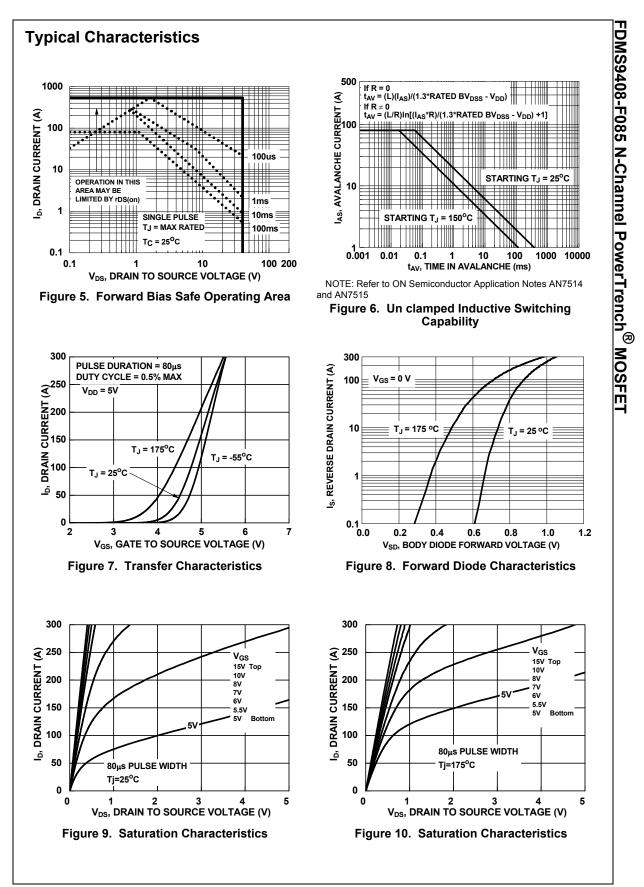
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9408	FDMS9408-F085	Power56	13"	12mm	3000units

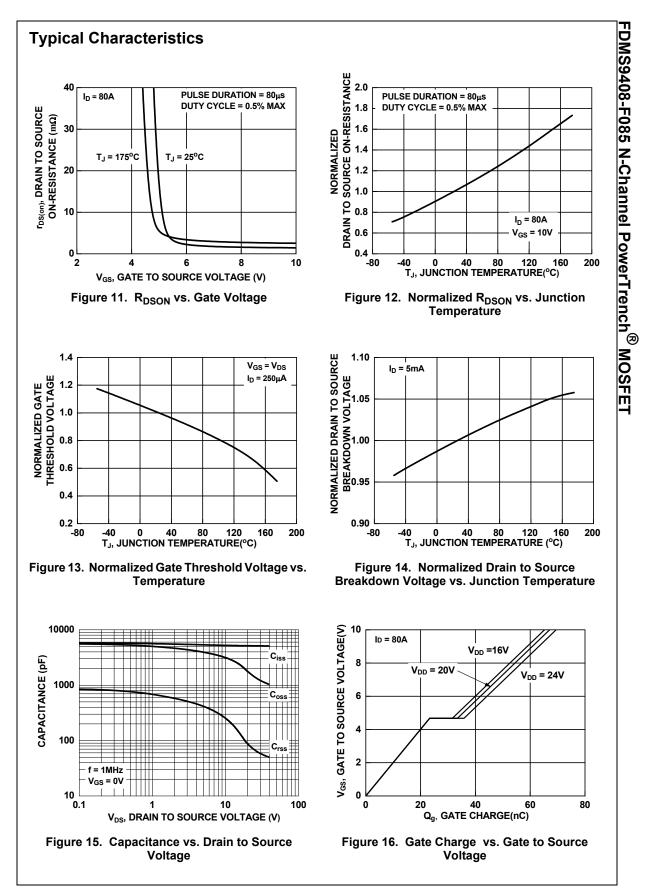
Units

Symbol	Parameter	Tes	t Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, '	V _{GS} =0V	40	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V_{DS} =40V, T_{J} = 25°C V_{GS} = 0V T_{J} = 175°C (Note 4)		-	-	1	μA mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} ,		2.0	3.0	4.0	V
R _{DS(on)}	Drain to Source On Resistance	I _D = 80A, V _{GS} = 10V	$T_J = 25^{\circ}C$ $T_J = 175^{\circ}C$ (Note 4)	-	1.5 2.5	1.8 3.0	mΩ mΩ
Dynami	ic Characteristics						
C _{iss}	Input Capacitance		(<u>0)</u> (-	5150	-	pF
C _{oss}	Output Capacitance	− V _{DS} = 20V, V f = 1MHz	/ _{GS} = 0V,	-	1770	-	pF
C _{rss}	Reverse Transfer Capacitance		-	-	89	-	pF
R _g	Gate Resistance	f = 1MHz		-	2.8	-	Ω
Q _{g(ToT)}	Total Gate Charge	V _{GS} = 0 to 1	0V V _{DD} = 32V	-	68	92	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to 2		-	9.3	14	nC
Q _{gs}	Gate-to-Source Gate Charge			-	22	-	nC
	Gate-to-Drain "Miller" Charge		-	-	12	-	nC
Q _{gd}							
Switchi	ng Characteristics			-	-	51	ns
Switchi t _{on} t _{d(on)}	Turn-On Time Turn-On Delay		- 904	-	19	-	ns
Switchi t _{on} t _{d(on)} t _r	Turn-On Time Turn-On Delay Rise Time	V _{DD} = 20V, V _{CS} = 10V.		-	19 20	-	ns ns
Switchi t _{on} t _{d(on)} t _r t _{d(off)}	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay	V _{DD} = 20V, V _{GS} = 10V,		-	19 20 41	- - -	ns ns ns
Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time			-	19 20	-	ns ns ns ns
t _{on} t _{d(on)} t _r t _{d(off)} t _f t _{off}	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay				19 20 41 19	- - -	ns ns ns
Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f t_{off} Drain-S	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time		R _{GEN} = 6Ω		19 20 41 19	-	ns ns ns ns
Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f t_{off} Drain-S	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time	V _{GS} = 10V,	R _{GEN} = 6Ω		19 20 41 19	- - - 79	ns ns ns ns
Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f t_{off}	Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time	V _{GS} = 10V,	R _{GEN} = 6Ω	- - - - -	19 20 41 19 -	- - - 79 1.25	ns ns ns ns V



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